

Value Engineering with Suppliers: A Proactive Approach



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ABSTRACT

Value Engineering process uses an organized approach to identify opportunities to eliminate or reduce non-value added costs from products or processes while assuring that quality, reliability, performances meet or exceed requirements. This paper is a collection of a few case studies of VA/VE efforts that were initiated in a semiconductor tool manufacturing company and successfully implemented in collaboration with the suppliers. The key point mentioned in this paper is to use simple and commonsense tools to make a significant cost savings for your company.

The important thing to learn here is that all organized efforts and right focus on an issue can bring success in the organization. In each project, highly pertinent elements of value analysis were applied in reaching the desired results and expectation of the company.

Three case studies illustrated in this paper are small parts, made out of low carbon steel, ceramic (aluminum nitrite) and fused quartz parts used in the semiconductor processing tools. In each case study pertinent value analysis techniques were used to reach the most cost effective solution.

Each case study follows the following format:

- ◆ Definition of the part/process problem
- ◆ Tools used for alternate solution
- ◆ Tests/validation conducted
- ◆ Net savings or improvement captured

To successfully implement any VE project in your organization, the first step is to identify the problem with the help of your customer. If you can obtain their support in identifying the problem and a few alternate solutions, you have won half the battle. The second important thing is to look around beyond your organization to obtain better solutions to the problems facing the organization. We have seen that suppliers who have expertise in their own organization can provide useful ideas for meaningful solutions of your problems. These ideas once carried through can be very valuable to your own organization.

This paper has illustrated the various steps that you need to go through to implement VE solutions successfully.

SUCCESS STORIES

Case-I Magnet Pole Piece

Problem definition:

Pole pieces are used on each side of a magnet, going into the slots of magnet clamp ring used in the robot assembly (Figure 1.0). Sixteen magnet assemblies are required for the upper magnet ring another sixteen for the lower vacuum magnet ring.

A total of sixty-four (64) pole pieces are needed for this assembly. The function of the pole pieces is to direct the magnetic flux lines in one direction in order to achieve maximum magnetic field strength. Therefore, one of the important properties of the pole piece material is low permeability.

cost, and profit margin. Cost reduction of ceramic chuck and the bellows assembly was a great challenge for the team. The key factor in the accuracy of "should cost" analysis lies in the accuracy of mapping the current processes steps. Each manufacturing process steps were challenged at the supplier's facility and non value-added tasks were eliminated.

A series of negotiation meetings were held with the suppliers and they were asked to meet the price as determined in the "should cost" analysis. Finally, contracts were signed with two suppliers to bring the price down to less than \$15K. Through VA/VE approach, we were able to achieve over 50% cost reduction for this part.

Net savings:

Total cost avoidance for this part was over \$8 million based on 1000 units of annual usage. This was possible due to proactive participation of Suppliers along with the Value Engineering group to solve common problems.

Case - III

Preclean Chamber Pin

Problem definition:

Preclean chamber in one of the critical process steps in physical vapor deposition (PVD) systems in semiconductor fabrication. It uses six small quartz pins to hold the wafer in position during preclean process. The existing pins are made out of fused quartz which goes through costly labor intensive manufacturing processes. This is a consumable item and costs per part is \$12.50 per piece. The objective was to find a material with the same physical and chemical properties as fused quartz at a lower cost so that cost of ownership (COO) can be improved.

Tools used for alternate solution:

The physical and chemical properties of the current materials were entered in a spreadsheet and an extensive research was carried out to find similar material at a lower cost.

Suppliers were contacted who had expertise in materials such as plastic, ceramic, glass and quartz. The two primary requirements of the property for the replacement material were: reduced particle generation and low dielectric constant (less than 4.0).

Two types of materials were short listed from a list of ten materials. These are (i) polybenzimidazole (PBI), (ii) vespel sp-1. The material properties of these materials were very close to the properties of

fused quartz.

Tests conducted:

Two process matrices were run on a system for a preclean chamber. The first matrix was run with the standard quartz pins. The second matrix was run with the new pins made out of PBI material. The RF power constants were set to 400. Two wafers were etched with standard quartz pins. The chamber was vented and the new pins (PBI material) were installed. Various process parameters such as DC bias, etch rate, and uniformity were used to compare the PBI pins to the quartz pins. A least square model was run for analysis. According to the analysis, PBI pins made no significant difference to the DC bias measurement (Table-II). The etch rates and uniformity differences were observed and recorded in Table-III and IV.

Net Savings:

Preclean chamber pin has a high annual usage. Cost reduction achieved was 75% by switching to the PBI pins. Net savings to the company is over \$281K per year. Details of cost savings achieved are shown in Table-V.

Conclusion:

The above success stories of Value Engineering group in my company are only a few out of many performed on a regular basis. VA/VE is a unique problem solving system for designing high-quality products at a low cost. Design and Manufacturing engineers have started recognizing the importance of VA/VE in product improvement and cost reduction efforts.

Case I and II discussed above have already been implemented. Case III is currently in the process of implementation.

Lessons Learned:

Variations between supplier's cost and "should cost" can be significant due to one or combination of the following reasons:

- ◆ Suppliers may not be using best known method (BKM) which leads to high cost
- ◆ High-cost manufacturing steps are not considered in the "should cost" analysis
- ◆ Suppliers have not adjusted the price for the current volume production
- ◆ Suppliers have not developed cost models -- quotes are prepared based on "guesstimates."

As the "should cost" model was presented to the suppliers which is a better analytical tool than traditional estimating practice, it helped us to conduct the negotiations more professionally and smoothly.

Table - I: Cost savings achieved for Pole Piece for Case I

Part No. 0020-XX, Rev. A Current Process: MIM	Part No. 0020-XX Rev. B New Process: CRF&M	Description: Pole Piece	Platform: Centura	Kit: HP Robot
Current cost	New Cost	Unit Savings	EAU	Total Savings (\$)
\$2.25	\$1.50	\$0.75	300,000	\$225,000.00

Table - II: DC bias comparison for Case III

Plasma Power	Bias Power	Quartz Pins	PBI Pins
450	150	59	59
600	200	59	56
750	250	56	54
200	100	126	123
400	200	105	104
600	300	102	101
200	200	263	263
300	300	242	247
400	400	234	236
150	300	502	508
150	450	483	486
225	450	674	682

Note: Table-II provides a comparison of the DC biases. The choice of pins make no difference to the DC biases.

Table- III: Etch rate comparison for Case III

Plasma Power	Bias Power	Quartz Pins	PBI Pins
450	150	309	225
600	200	412	312
750	250	507	403
200	100	164	113
400	200	405	337
600	300	630	551
200	200	294	241
300	300	504	441
400	400	714	641
150	300	316	267
150	450	417	357
225	450	559	485

Note: Table-III presents a comparison of the etch rates with the new pins and the quartz pins. The etch rates with the new pins are considerably lower than the etch rates with the quartz pins.

Table- IV: Uniformity comparison for Case III

Plasma Power	Bias Power	Quartz Pins	PBI Pins
450	150	2.4	3.9
600	200	5.7	4.6
750	250	4.0	4.1
200	100	1.9	2.3
400	200	2.1	2.1
600	300	3.2	3.0
200	200	2.7	2.7
300	300	2.4	2.1
400	400	2.3	2.2
150	300	6.6	6.9
150	450	8.4	9.0
225	450	4.6	4.8

Note: Table- IV provides a comparison of the uniformity between new pins and quartz pins. The new pins (PBI) neither improve nor degrade the uniformity.

Table -V: Cost savings achieved for Preclean Chamber Pin: Case III

Part No. 0020-ZZZ, Rev. A Current Material: Quartz GE-124	Part No. 0020-ZZZ Rev. B New Material: PBI	Description: Preclean Chamber Pin	Platform: Centura &Endura PVD	Kit: Preclean Chamber
Current cost	New Cost	Unit Savings	EAU	Total Savings (\$)
\$12.50	\$3.11	\$9.39	30,000	\$281,700 .00

Figure 2.0: BH curve of Pole piece
for MIM (existing) process

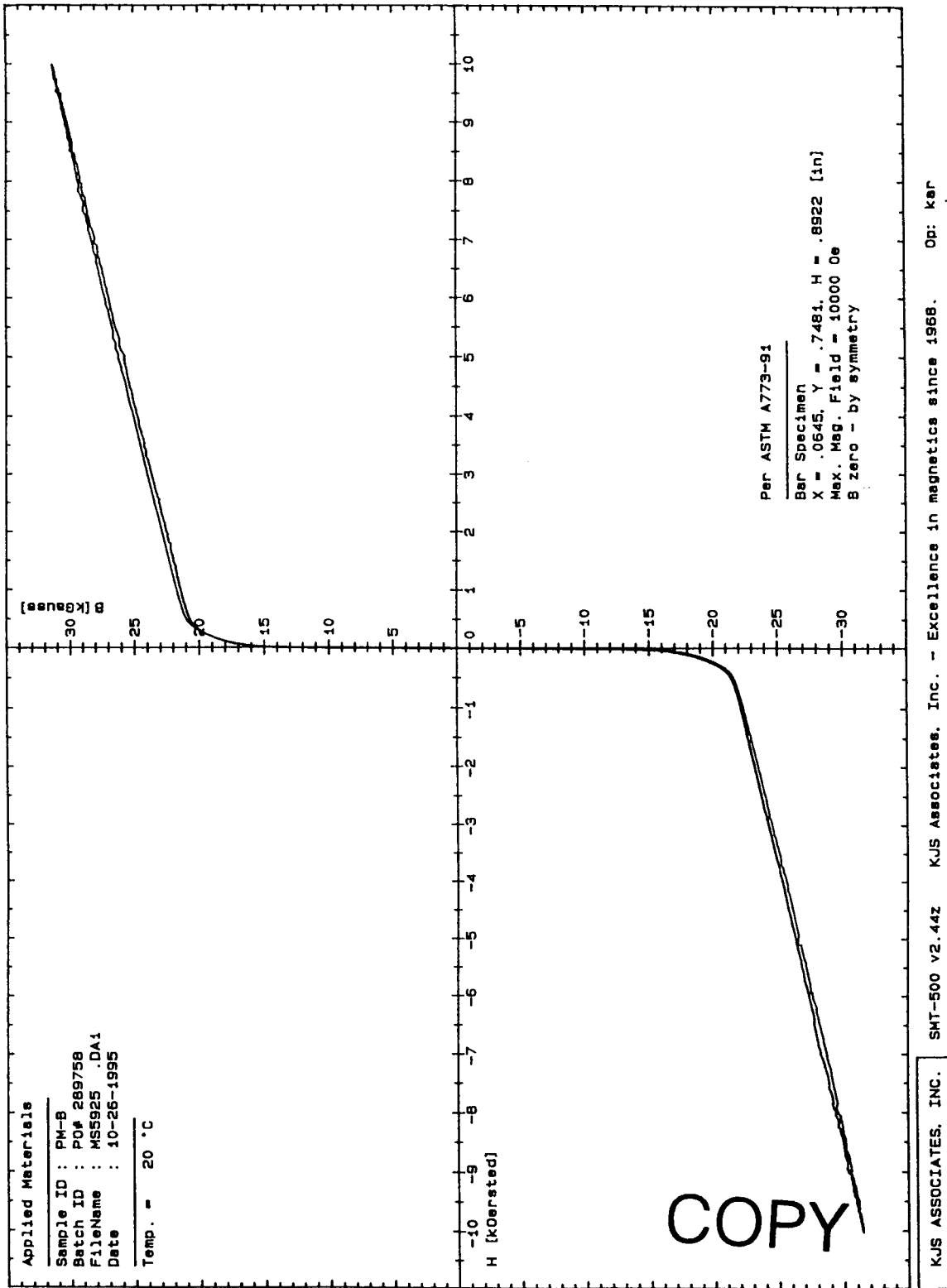


Figure 3.0: BH curve of Pole piece
for powder metal process

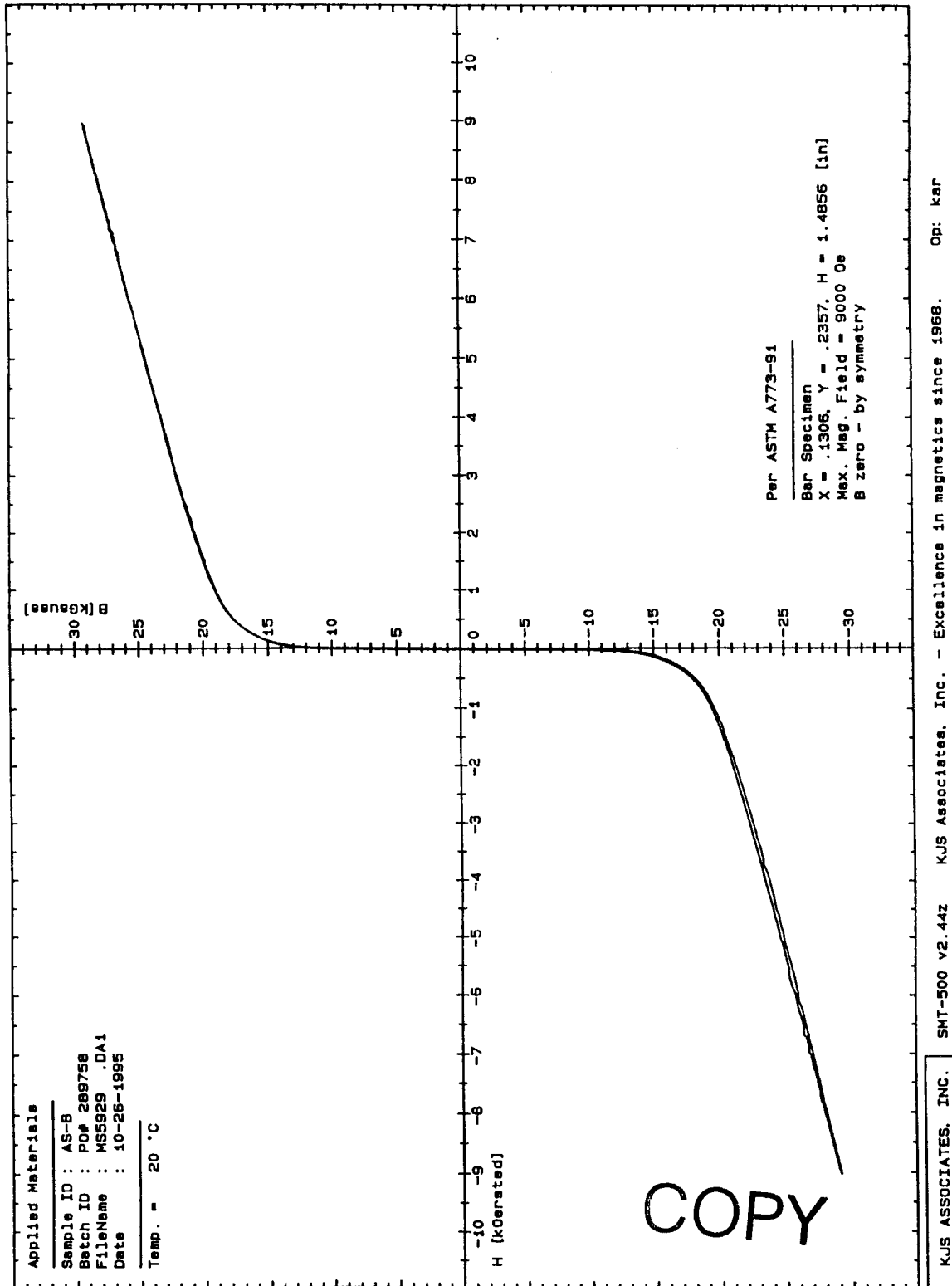


Figure 4.0: BH curve of Pole piece for "cold forming and machining" process

